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PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10058854	01/28/2002	257	3-5.5	2820 2011	23 DEC-GLI RRC

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\*\*CONTINUING DATA VERIFIED:  
THIS APPLN CLAIMS BENEFIT OF 60/340.554 12/14/2001

\*\* FOREIGN APPLICATIONS VERIFIED:

None 9/15

PG-PUB	DO NOT PUBLISH <input checked="" type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO	
35 USC 119 conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	1458.TT47962	
Verified and Acknowledged Examiner's initials 11/11			
TITLE : System for forming a semiconductor device and method thereof			

U.S. DEPT. OF COMM./PAT. & TM-PTO-43BL (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.	Print Fig.
TERMINAL DISCLAIMER		Primary Examiner		Application Examiner
PREPARED FOR ISSUE				
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